onsemi

<u>Silicon Carbide (SiC)</u> <u>Schottky Diode</u> – EliteSiC, 10 A, 650 V, D2, TO-220-2L

FFSP1065B

Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.

Features

- Max Junction Temperature 175°C
- Avalanche Rated 49 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery / No Forward Recovery
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- General Purpose
- SMPS, Solar Inverter, UPS
- Power Switching Circuit

ABSOLUTE MAXIMUM RATINGS

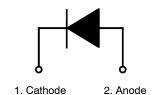
(T_C = 25°C, Unless otherwise specified)

Symbol	Parame	Value	Unit		
V _{RRM}	Peak Repetitive Reverse	650	V		
E _{AS}	Single Pulse Avalanche I	49	mJ		
١ _F	Continuous Rectified For T _C < 139°C	10	A		
	Continuous Rectified For $T_C < 135^{\circ}C$	11			
I _{F, Max}	Ion-Repetitive Peak	T _C = 25°C, 10 μs	650	А	
	Forward Surge Current	T _C = 150°C, 10 μs	570		
I _{F, SM}	Non-Repetitive Forward Surge Current	Half–Sine Pulse, t _p = 8.3 ms	45	A	
P _{tot}	Power Dissipation	$T_{C} = 25^{\circ}C$	75	W	
		T _C = 150°C	12.5		
T _J , T _{STG}	Operating and Storage T	-55 to +175	°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

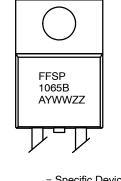
1. E_{AS} of 49 mJ is based on starting T_J = 25°C, L = 0.5 mH, I_{AS} = 14 A, V = 50 V.

ELECTRICAL CONNECTION





MARKING DIAGRAM



FFSP1065B	= Specific Device Code
Α	= Assembly Location
Y	= Year
WW	= Work Week
ZZ	= Assembly Lot Code

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

FFSP1065B

THERMAL CHARACTERISTICS

Symbol	Parameter	Ratings	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	2.0	°C/W

ELECTRICAL CHARACTERISTICS $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _F	Forward Voltage	I _F = 10 A, T _C = 25°C	-	1.38	1.7	V
		I _F = 10 A, T _C = 125°C	-	1.6	2.0	
		I _F = 10 A, T _C = 175°C	-	1.72	2.4	
I _R	Reverse Current	$V_R = 650 \text{ V}, \text{ T}_C = 25^{\circ}\text{C}$	-	0.5	40	μΑ
		$V_{R} = 650 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$	-	1.0	80	
		$V_{R} = 650 \text{ V}, \text{ T}_{C} = 175^{\circ}\text{C}$	-	2.0	160	
Q _C	Total Capacitive Charge	V = 400 V	-	25	-	nC
С	Total Capacitance	V _R = 1 V, f = 100 kHz	-	421	-	pF
		V _R = 200 V, f = 100 kHz	-	46	-	1
		V _R = 400 V, f = 100 kHz	-	35	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FFSP1065B	FFSP1065B	TO-220-2L	Tube	N/A	N/A	50 Units

FFSP1065B

TYPICAL CHARACTERISTICS $T_J = 25^{\circ}C$ UNLESS OTHERWISE NOTED

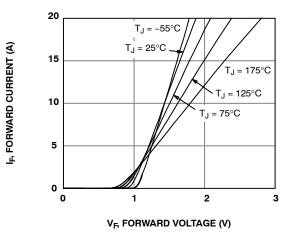
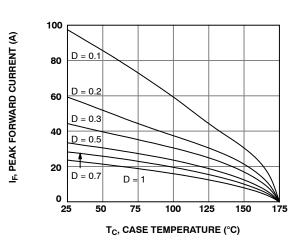
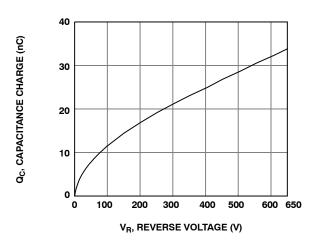


Figure 1. Forward Characteristics









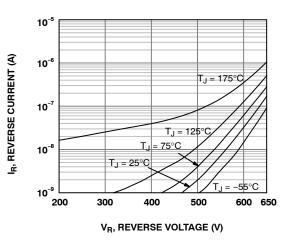


Figure 2. Reverse Characteristics

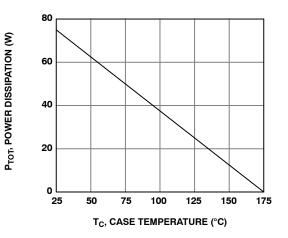
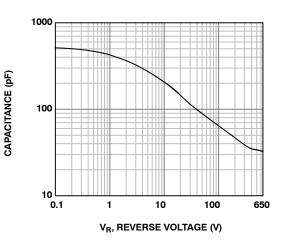
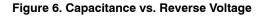


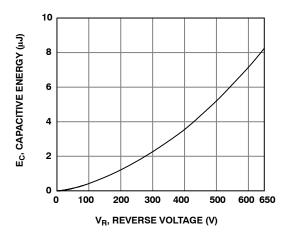
Figure 4. Power Dissipation

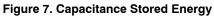


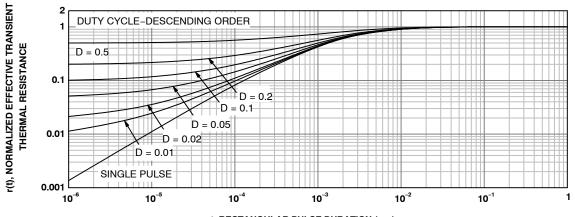


FFSP1065B

TYPICAL CHARACTERISTICS $T_J = 25^{\circ}C$ UNLESS OTHERWISE NOTED (CONTINUED)

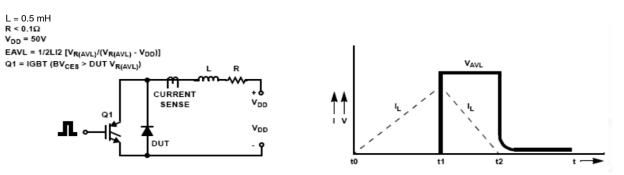






t, RECTANGULAR PULSE DURATION (sec)

Figure 8. Junction-to-Case Transient Thermal Response Curve



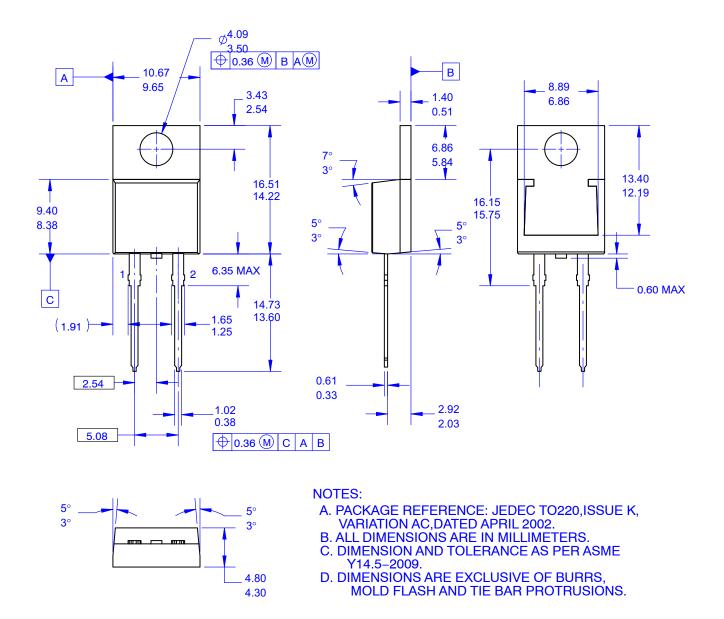
TEST CIRCUIT AND WAVEFORMS

Figure 9. Unclamped Inductive Switching Test Circuit & Waveform



TO-220-2LD CASE 340BB ISSUE O

DATE 31 AUG 2016



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